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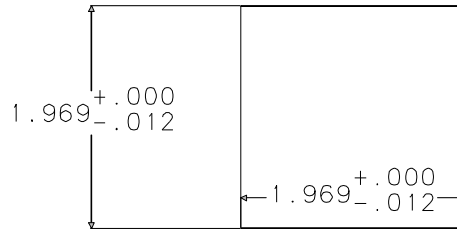
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DWG. NO. A - 2738 SH REV. A

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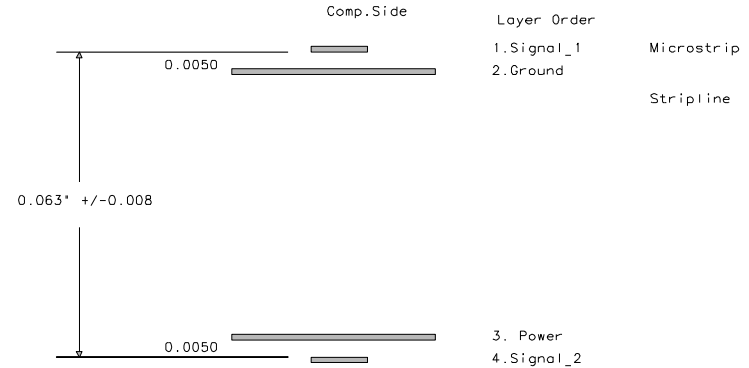
D

D



C

C



B

B

Board Characteristics

- All dimensions are given in inches unless specified otherwise.
- Minimum trace width and clearance: $0.006''$ on Signal_1,6 (Top and Bottom);
- Impedance Control: 60 Ohm for all 6-mil signal traces;
- 10z Copper for all layers;
- Apply Solder Mask over bare copper.
- Board Thickness: $0.063'' \pm 0.008$
- Silkscreen on Component and Solder Sides.
- FHS tolerances: ± 0.003 unless specified otherwise.
- Interlayer spacing as specified

A

A

BOARD'S DRILL SCHEDULE

DRILL SYMBOL	DRILL SIZE	COUNT	PLATED	Tolerance	COMMENT
○	.01	75	YES	---	
⊞	.011811024	12	YES	---	
⊙	.013	8	YES	---	
⊞	.041	25	YES	---	
⊙	.057	4	YES	---	
⊞	.104	4	YES	---	

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES ARE: FRACTIONS DECIMALS ANGLES XXX DO NOT SCALE DRAWING			CONTRACT NO.		UNIVERSITY OF CHICAGO ELECTRONICS DEVELOPMENT GROUP			
TREATMENT			APPROVALS	DATE	TITLE			
FINISH			DRAWN M. Bogdan	5/15/11	1 GHz PreAmp Board Specification Drawing			
SIMILAR TO			CHECKED M. Bogdan	4/15/11	SIZE B	FSCM NO.	DWG. NO. 2738	REV. A
ACT. WT	CALC. WT		ISSUED		SCALE 1/1		SHEET	

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